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IN THE SPECIFICATION

*Page 10, insert after the heading "Detailed Description of the Preferred Embodiment" but before the heading "First embodiment," the following paragraph:*

C1 In the present disclosure, the term "width" refers to the dimension of the first and second semiconductor regions 1, 2 along the pitch direction P1, P2. The terms "lateral width" refers to the dimension of the first and second semiconductor regions 1, 2 perpendicular to the pitch direction P1, P2.